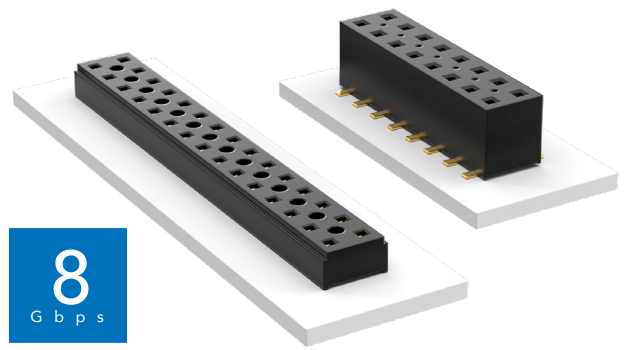


COST-EFFECTIVE & DUAL WIPE SOCKETS

(2.00 mm) .0787" PITCH • TLE/CLT SERIES



TLE

Mates:

TMMH, TMM, MTMM,
MMT, TW, LTMM, ZLTMM,
TCMD, TSH

CLT

Mates:

TMM, TMMH, MTMM,
MMT, TW, TSH

SPECIFICATIONS

TLE

Insulator Material:

Black Liquid Crystal Polymer

Contact Material:

Phosphor Bronze

Plating:

Au over 50 μ " (1.27 μ m) Ni

Operating Temp Range:

-55 °C to +125 °C

Current Rating (TLE/TMMH):

3.2 A per pin (2 pins powered)

Voltage Rating:

406 VAC/574 VDC

Insertion Depth:

(2.08 mm) .082" to
(4.37 mm) .172" with
(0.38 mm) .015" wipe,
pass-through, or
(3.35 mm) .132" min
for bottom entry

CLT

Same as TLE except:

Plating:

Sn or Au over 50 μ " (1.27 μ m) Ni

Current Rating (CLT/TMMH):

4.2 A per pin (2 pins powered)

Voltage Rating:

405 VAC/573 VDC

Insertion Depth:

Top Entry=
(1.40 mm) .055" minimum
Bottom Entry=
(2.57 mm) .101" minimum
(add board thickness for
correct post OAL)

Max Cycles:

100 with 10 μ " (0.25 μ m) Au

PROCESSING

TLE

Lead-Free Solderable: Yes

SMT Lead Coplanarity:

(0.10 mm) .004" max (02-26)
(0.15 mm) .006" max (26-34)*

*(.004" stencil solution
may be available; contact
ipg@samtec.com)

CLT

Same as TLE except:

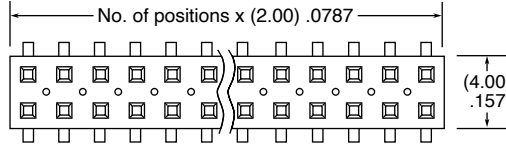
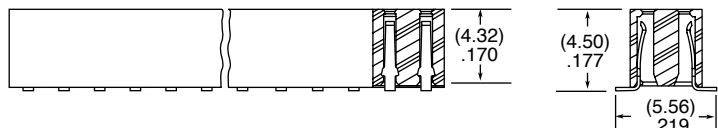
SMT Lead Coplanarity:

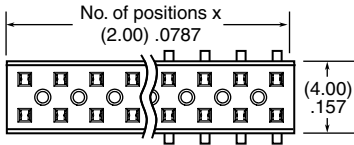
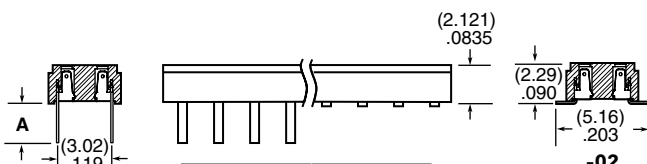
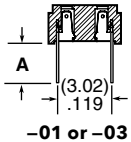
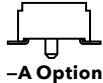
(0.10 mm) .004" max (02-25)
(0.15 mm) .006" max (26-34)*
(0.20 mm) .008" max (35-50)*

*(.004" stencil solution
may be available; contact
ipg@samtec.com)

Note:

Some lengths, styles and
options are non-standard,
non-returnable.

TLE	- 1	NO. PINS PER ROW	- 01	PLATING OPTION	- DV	OPTIONS
		02 thru 50			-G = 10 μ " (0.25 μ m) Gold	-A = Alignment Pin (3 positions minimum) -K = (5.00 mm) .197" DIA Polyimide Film Pick & Place Pad (3 positions minimum) -P = Metal Pick & Place Pad (4 positions minimum) -TR = Tape & Reel Packaging (2-37 positions only) -FR = Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks) (2-37 positions only)
						
						
						

CLT	- 1	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	- D	OTHER OPTIONS					
		02 thru 50	-01 = Through-hole -02 = Surface Mount -03 = Through-hole	-F = Gold flash on contact, Matte Tin on tail -L = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail -G = 10 μ" (0.25 μm) Gold on contact, Gold flash on tail		All options require Style -02 -BE = Bottom Entry (Required for bottom entry applications) -A = Alignment Pin (3 positions minimum) Metal or plastic at Samtec's discretion -K = (5.00 mm) .197" DIA Polyimide Film Pick & Place Pad (04 thru 50 only) -P = Pick & Place Pad (4 positions minimum) -TR = Tape & Reel (36 positions max) -FR = Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks) (36 positions max)					
ALSO AVAILABLE Contact Samtec											
Other Platings											
											
											
											
											
											
											
<table><tr><th>LEAD STYLE</th><th>A</th></tr><tr><td>-01</td><td>(2.16) .085</td></tr><tr><td>-03</td><td>(2.95) .116</td></tr></table>		LEAD STYLE	A	-01	(2.16) .085	-03	(2.95) .116				
LEAD STYLE	A										
-01	(2.16) .085										
-03	(2.95) .116										